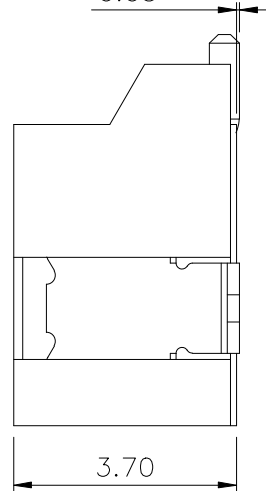


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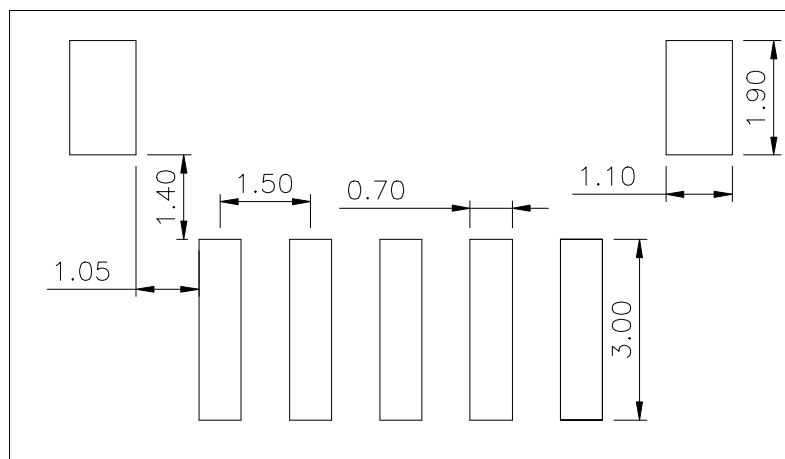
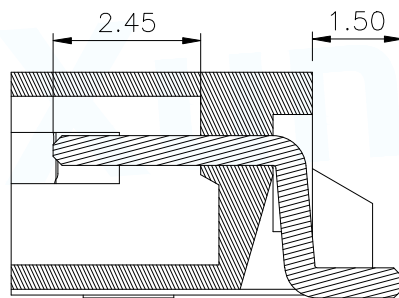
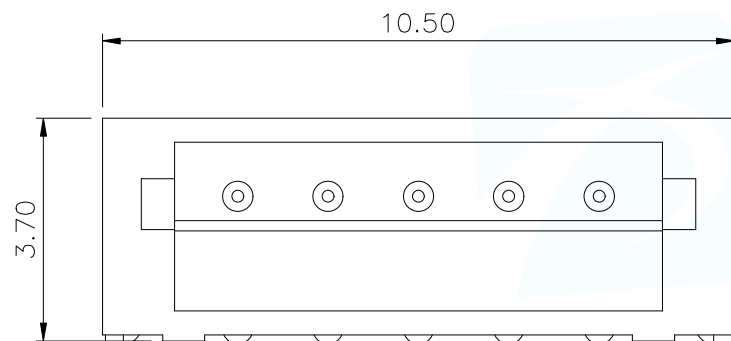


NOTES:

- 1.MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V_0
CONTACT: COPPER ALLOYS.
COVER: COPPER ALLOYS OR STEEL.
- 2.PLATING:
UNDERPLATE: NICKEL.

SPECIFICATIONS:

Voltage Rating:125V AC DC
Current Rating:1A AC,DC
Withstanding voltage:500V AC 1/Minute
Insulation Resistance:100MΩ Min
Contact Resistance:20mΩ Max
Temperatuer Range:-25℃ ~+ 85℃



RECOMMENDED P.C.B HOLE LAYOUT

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	TITLE: WAFER 1.50 5P	
UNLESS OTHERWISE SPECIFIED TOLERANCES			PAR	WAFER-150W-5P
DECIMALS:	ANGLES:	DWN		
X.X:±0.35	X.X':±3°	CHKD		
X.XX:±0.25	X.XX:±2'	APVD		
X.XXX:±0.15		SCALE1:1	UNIT:MM	
		CUSTOMER COPY		
		SIZE:A4	UNIT:MM	
		SHEET:1F1	REV:A	